Preferred Device

Sensitive Gate Triacs

Silicon Bidirectional Thyristors

Designed primarily for industrial and consumer applications for full wave control of ac loads such as appliance controls, heater controls, motor controls, and other power switching applications.

Features

- Pb-Free Packages are Available
- Sensitive Gate Triggering in 3 Modes for AC Triggering on Sinking Current Sources
- Four Mode Triggering for Drive Circuits that Source Current
- All Diffused and Glass–Passivated Junctions for Parameter Uniformity and Stability
- Small, Rugged, Thermowatt Construction for Low Thermal Resistance and High Heat Dissipation
- Center Gate Geometry for Uniform Current Spreading

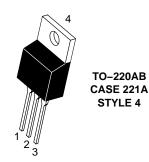


ON Semiconductor®

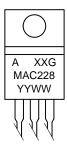
http://onsemi.com

TRIACS 8 AMPERES RMS 200 – 800 VOLTS









X = 4, 6, 8, or 10 YY = Year WW = Work Week G = Pb-Free

ORDERING INFORMATION

Device	Package	Shipping [†]
MAC228A4	TO-220	500 Units/Box
MAC228A6	TO-220	500 Units/Box
MAC228A8	TO-220	500 Units/Box
MAC228A8G	TO-220 (Pb-Free)	500 Units/Box
MAC228A10	TO-220	500 Units/Box
MAC228A10G	TO-220 (Pb-Free)	500 Units/Box

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Preferred devices are recommended choices for future use and best overall value.

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MAXIMUM RATINGS ($T_J = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Value	Unit	
Peak Repetitive Off–State Voltage (Note 1) (T _J = -40 to 110°C, Sine Wave, 50 to 60 Hz, Gate Open)	MAC228A4 MAC228A6 MAC228A8 MAC228A10	V _{DRM} , V _{RRM}	200 400 600 800	V
On-State RMS Current, $(T_C = 80^{\circ}C)$ – Full Cycle Sine Wave 50 to 60 Hz		I _{T(RMS)}	8.0	А
Peak Non–Repetitive Surge Current (One Full Cycle Sine Wave, 60 Hz, T _J = 110°C)		I _{TSM}	80	А
Circuit Fusing Considerations, (t = 8.3 ms)		l ² t	26	A ² s
Peak Gate Current, (t \leq 2 μ s, T _C = 80°C)	I _{GM}	±2.0	Α	
Peak Gate Voltage, (t \leq 2 μ s, T _C = 80°C)		V_{GM}	±10	V
Peak Gate Power, (t \leq 2 μ s, T _C = 80°C)		P _{GM}	20	W
Average Gate Power, (t \leq 8.3 ms, T _C = 80°C)		P _{G(AV)}	0.5	W
Operating Junction Temperature Range		TJ	-40 to 110	°C
Storage Temperature Range		T _{stg}	-40 to 150	°C
Mounting Torque			8.0	in lb

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Characteristic		Value	Unit
Thermal Resistance – Junction–to–Case	$R_{ heta JC}$	2.0	°C/W
Thermal Resistance – Junction–to–Ambient	$R_{ heta JA}$	62.5	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds		260	°C

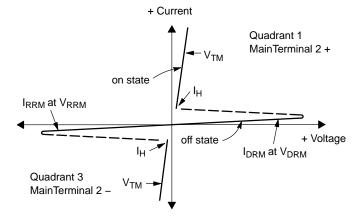
ELECTRICAL CHARACTERISTICS (Tc = 25°C unless otherwise noted: Electricals apply in both directions)

Characteristic	Symbol	Min	Тур	Max	Unit
DFF CHARACTERISTICS					
Peak Repetitive Blocking Current, (V_D = Rated V_{DRM} , V_{RRM} ; Gate Open) $T_J = 25^{\circ}C$ $T_J = 110^{\circ}C$	I _{DRM} , I _{RRM}	-	_ _	10 2.0	μA mA
N CHARACTERISTICS		-	-	-	
Peak On-State Voltage, ($I_{TM} = \pm 11$ A Peak, Pulse Width ≤ 2 ms, Duty Cycle $\leq 2\%$)	V_{TM}	_	-	1.8	V
Gate Trigger Current (Continuous DC), (V_D = 12 V, R_L = 100 Ω) MT2(+), G(+); MT2(+), G(-); MT2(-), G(-) MT2(-), G(+)	I _{GT}	- -	- -	5.0 10	mA
Gate Trigger Voltage (Continuous DC), (V_D = 12 V, R_L = 100 Ω) MT2(+), G(+); MT2(+), G(-); MT2(-), G(-) MT2(-), G(+)	V _{GT}	- -	- -	2.0 2.5	V
Gate Non–Trigger Voltage (Continuous DC), (V $_D$ = 12 V, T $_C$ = 110°C, R $_L$ = 100 $\Omega)$ All Four Quadrants		0.2	-	-	V
Holding Current, ($V_D = 12 \text{ Vdc}$, Initiating Current = $\pm 200 \text{ mA}$, Gate Open)		_	_	15	mA
Gate–Controlled Turn–On Time, (V _D = Rated V _{DRM} , I _{TM} = 16 A Peak, I _G = 30 mA)		_	1.5	-	μS
YNAMIC CHARACTERISTICS					
Critical Rate of Rise of Off-State Voltage, $(V_D = Rated V_{DRM}, Exponential Waveform, T_C = 110^{\circ}C)$		-	25	-	V/μs
Critical Rate of Rise of Commutation Voltage, (V_D = Rated V_{DRM} , I_{TM} = 11.3 A, Commutating di/dt = 4.1 A/ms, Gate Unenergized, T_C = 80°C)		-	5.0	-	V/μs

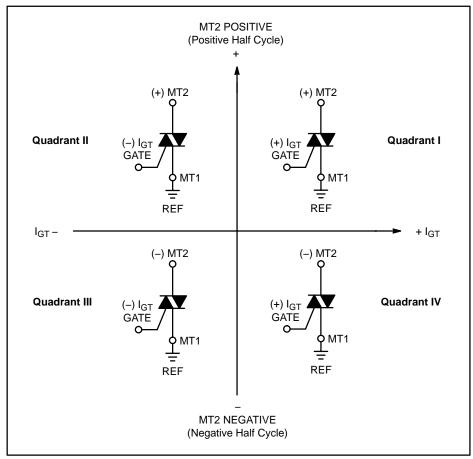
damage may occur and reliability may be affected.
 V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

Voltage Current Characteristic of Triacs (Bidirectional Device)

Symbol	Parameter
V_{DRM}	Peak Repetitive Forward Off State Voltage
I _{DRM}	Peak Forward Blocking Current
V_{RRM}	Peak Repetitive Reverse Off State Voltage
I _{RRM}	Peak Reverse Blocking Current
V _{TM}	Maximum On State Voltage
I _H	Holding Current

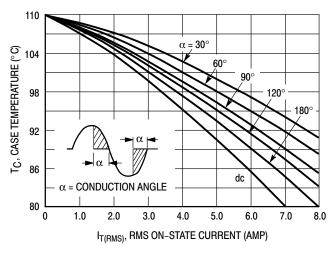


Quadrant Definitions for a Triac



All polarities are referenced to MT1.

With in-phase signals (using standard AC lines) quadrants I and III are used.





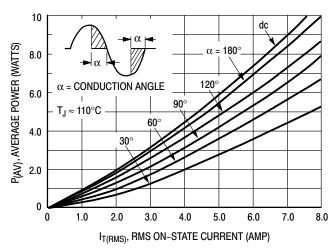
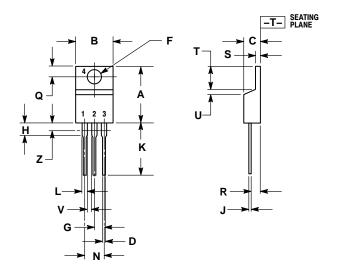


Figure 2. On-State Power Dissipation

PACKAGE DIMENSIONS

TO-220 **PLASTIC** CASE 221A-09 **ISSUE AA**



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
С	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
Н	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
٧	0.045		1.15	
Z		0.080		2.04

- STYLE 4:
 PIN 1. MAIN TERMINAL 1
 2. MAIN TERMINAL 2
 3. GATE
 4. MAIN TERMINAL 2

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